1. General description

NPN general-purpose transistor in an ultra small DFN1412D-3 (SOT8009) leadless Surface-Mounted Device (SMD) plastic package with side-wettable flanks.

Table 1. Product overview

Type number	Package			nber Package		PNP complement
	Name	JEDEC	Version			
BC817-16QCH-Q	DFN1412D-3	MO-340CA	SOT8009	BC807-16QCH-Q		
BC817-25QCH-Q				BC807-25QCH-Q		
BC817-40QCH-Q				BC807-40QCH-Q		

2. Features and benefits

- · High power dissipation capability
- High current
- · Three current gain selections
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- Smaller footprint compared to conventional leaded SMD packages
- Low package height of 0.5 mm
- High-temperature applications up to 175 °C
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- · General-purpose switching and amplification
- Space restricted applications

4. Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base; T _{amb} = 25 °C	-	-	45	V
I _C	collector current	T _{amb} = 25 °C	-	-	500	mA
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms; T _{amb} = 25 °C	-	-	1	А
h _{FE}	DC current gain					
	BC817-16QCH-Q	$V_{CE} = 1 \text{ V}; I_{C} = 100 \text{ mA T}_{amb} = 25 \text{ °C}$ [1]	100	-	250	
	BC817-25QCH-Q		160	-	400	
	BC817-40QCH-Q		250	-	600	

[1] pulsed; $t_p \le 300 \ \mu s; \ \delta \le 0.02$



5. Pinning information

Table 3. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base	الى يى كا	С
2	Е	emitter	3	, , ,
3	С	collector		B — [
			1 2	E sym021
			Transparent top view DFN1412D-3 (SOT8009)	

6. Ordering information

Table 4. Ordering information

Type number	Package	ckage					
	Name	Description	Version				
BC817-16QCH-Q	DFN1412D-3	DFN1412D-3: plastic thermal enhanced ultra thin small outline	SOT8009				
BC817-25QCH-Q		package; no leads; 3 terminals; body: 1.4 x 1.2 x 0.5 mm	(MO-340CA)				
BC817-40QCH-Q							

7. Marking

Table 5. Marking

Type number	Marking code
BC817-16QCH-Q	8V
BC817-25QCH-Q	8W
BC817-40QCH-Q	8Y

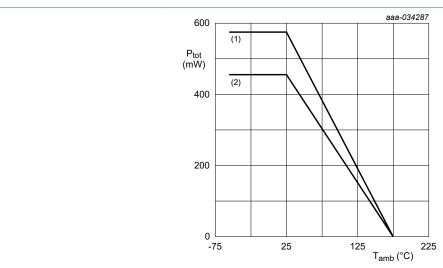
8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter; T _{amb} = 25 °C	open emitter; T _{amb} = 25 °C		50	V
V_{CEO}	collector-emitter voltage	open base; T _{amb} = 25 °C	open base; T _{amb} = 25 °C		45	V
V_{EBO}	emitter-base voltage	open collector; T _{amb} = 25 °C	open collector; T _{amb} = 25 °C		5	V
I _C	collector current	T _{amb} = 25 °C	T _{amb} = 25 °C		500	mA
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms; T _{amb}	single pulse; t _p ≤ 1 ms; T _{amb} = 25 °C		1	А
I _{BM}	peak base current	single pulse; t _p ≤ 1 ms; T _{amb}	single pulse; t _p ≤ 1 ms; T _{amb} = 25 °C		200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	455	mW
			[2]	-	575	mW
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 35 µm copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided 70 µm copper, tin-plated and standard footprint.



- (1) FR4 PCB; single-sided 70 µm copper, tin-plated and standard footprint
- (2) FR4 PCB; single-sided 35 µm copper, tin-plated and standard footprint

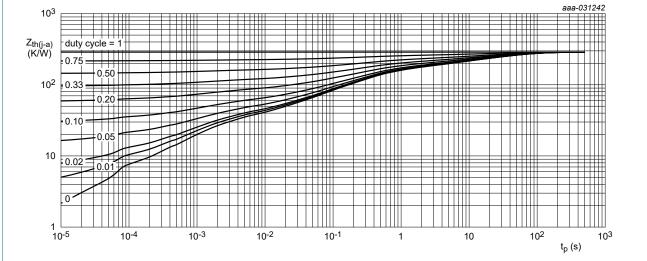
Fig. 1. Power derating curves for SOT8009

9. Thermal characteristics

Table 7. Thermal characteristics

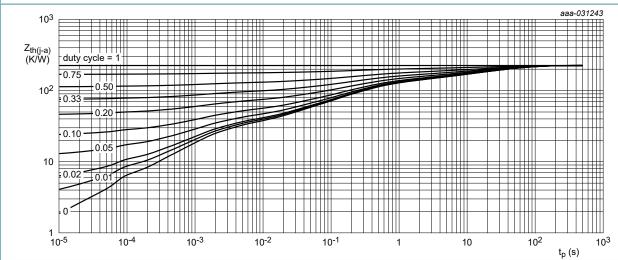
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air;	[1]	-	-	329	K/W
		T _{amb} = 25 °C	[2]	-	-	261	K/W

- [1] Device mounted on an FR4 PCB, single-sided 35 µm copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided 70 µm copper, tin-plated and standard footprint.



FR4 PCB, single-sided 35µm copper, tin-plated and standard footprint

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, single-sided 70µm copper, tin-plated and standard footprint

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

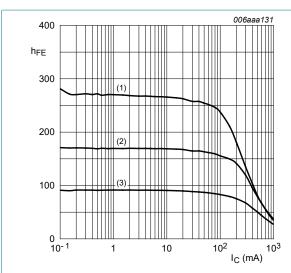
10. Characteristics

Table 8. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)CBO}$	collector-base breakdown voltage	I _C = 100 μA; I _E = 0 A; T _{amb} = 25 °C	50	-		V
V _{(BR)CEO}	collector-emitter breakdown voltage	I _C = 10 mA; I _E = 0 A; T _{amb} = 25 °C	45	-		V
V _{(BR)EBO}	emitter-base breakdown voltage	$I_E = 100 \mu A; I_C = 0 A; T_{amb} = 25 °C$	5	-		V
I _{CBO}	collector-base	V _{CB} = 20 V; I _E = 0 A; T _{amb} = 25 °C	-	-	100	nA
	cut-off current	V _{CB} = 20 V; I _E = 0 A; T _j = 150 °C	-	-	5	μA
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0 A; T _{amb} = 25 °C	-	-	100	nA
h _{FE}	DC current gain			'		'
	BC817-16QCH-Q	$V_{CE} = 1 \text{ V}; I_{C} = 100 \text{ mA}; T_{amb} = 25 \text{ °C}$ [1] 100	-	250	
	BC817-25QCH-Q		160	-	400	
	BC817-40QCH-Q	_	250	-	600	
		V _{CE} = 1 V; I _C = 500 mA; T _{amb} = 25 °C [1] 40	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}; T_{amb} = 25 \text{ °C}$ [1] -	-	700	mV
V_{BE}	base-emitter voltage	$V_{CE} = 1 \text{ V; } I_{C} = 500 \text{ mA; } T_{amb} = 25 \text{ °C}$ [1]		-	1.2	V
f _T	transition frequency	V _{CE} = 5 V; I _C = 10 mA; f = 100 MHz; T _{amb} = 25 °C	100	-	-	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0 \text{ A}; f = 1 \text{ MHz}; T_{amb} = 25 \text{ °C}$	-	3	-	pF

^[1] pulsed; $t_p \le 300 \ \mu s$; $\delta \le 0.02$

^[2] V_{BE} decreases by about 2 mV/K with increasing temperature.



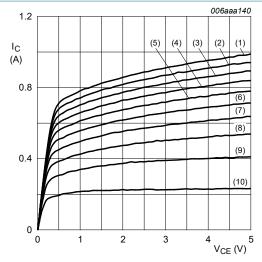
$$V_{CE} = 1 V$$

(1)
$$T_{amb} = 150 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Fig. 4. BC817-16QCH-Q: DC current gain as a function of collector current; typical values



(1)
$$I_B = 16.0 \text{ mA}$$

(2)
$$I_B = 14.4 \text{ mA}$$

(3)
$$I_B = 12.8 \text{ mA}$$

(4)
$$I_B = 11.2 \text{ mA}$$

$$(5) I_B = 9.6 \text{ mA}$$

(6)
$$I_B = 8.0 \text{ mA}$$

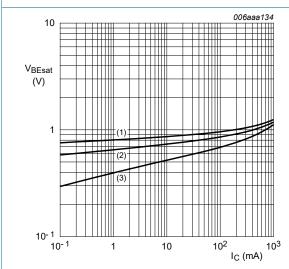
$$(7) I_B = 6.4 \text{ mA}$$

(8)
$$I_B = 4.8 \text{ mA}$$

(9)
$$I_B = 3.2 \text{ mA}$$

(10)
$$I_B = 1.6 \text{ mA}$$

Fig. 5. BC817-16QCH-Q: Collector current as a function of collector-emitter voltage; typical values

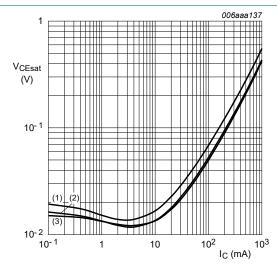


(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = 150 \, ^{\circ}C$$

Fig. 6. BC817-16QCH-Q: Base-emitter saturation voltage as a function of collector current; typical values



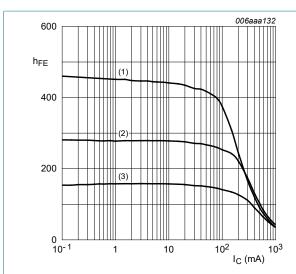
(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Fig. 7. BC817-16QCH-Q: Collector-emitter saturation voltage as a function of collector current; typical values

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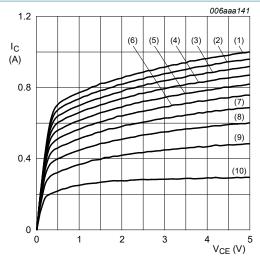
$$V_{CE} = 1 V$$

(1)
$$T_{amb} = 150 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Fig. 8. BC817-25QCH-Q: DC current gain as a function of collector current; typical values



(1)
$$I_B = 13.0 \text{ mA}$$

(2)
$$I_B = 11.7 \text{ mA}$$

(3)
$$I_B = 10.4 \text{ mA}$$

(4)
$$I_B = 9.1 \text{ mA}$$

$$(5) I_B = 7.8 \text{ mA}$$

(6)
$$I_B = 6.5 \text{ mA}$$

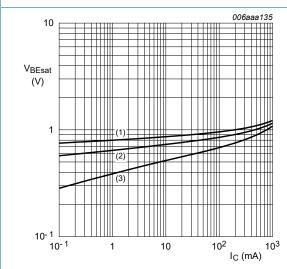
$$(7) I_B = 5.2 \text{ mA}$$

(8)
$$I_B = 3.9 \text{ mA}$$

(9)
$$I_B = 2.6 \text{ mA}$$

(10)
$$I_B = 1.3 \text{ mA}$$

Fig. 9. BC817-25QCH-Q: Collector current as a function of collector-emitter voltage; typical values

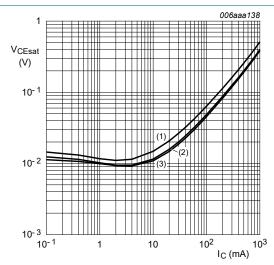


(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = 150 \, ^{\circ}C$$

Fig. 10. BC817-25QCH-Q: Base-emitter saturation voltage as a function of collector current; typical values



(1)
$$T_{amb} = 150 \, ^{\circ}C$$

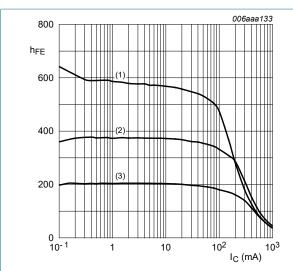
(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Fig. 11. BC817-25QCH-Q: Collector-emitter saturation voltage as a function of collector current; typical values

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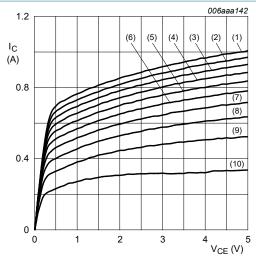


$$V_{CE} = 1 V$$

(1)
$$T_{amb} = 150 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Fig. 12. BC817-40QCH-Q: DC current gain as a function of collector current; typical values



(1)
$$I_B = 12.0 \text{ mA}$$

(2)
$$I_B = 10.8 \text{ mA}$$

(3)
$$I_B = 9.6 \text{ mA}$$

$$(4) I_B = 8.4 \text{ mA}$$

$$(5) I_B = 7.2 \text{ mA}$$

(6)
$$I_B = 6.0 \text{ mA}$$

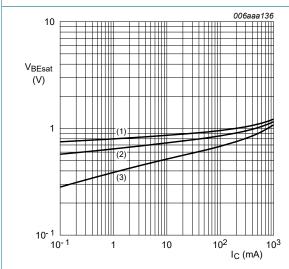
$$(7) I_B = 4.8 \text{ mA}$$

(8)
$$I_B = 3.6 \text{ mA}$$

(9)
$$I_B = 2.4 \text{ mA}$$

$$(10) I_B = 1.2 \text{ mA}$$

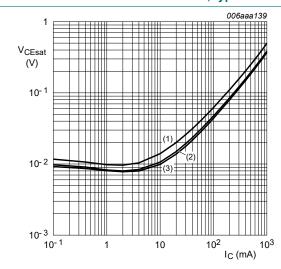
Fig. 13. BC817-40QCH-Q: Transition frequency as a function of collector current; typical values



$$IC/IB = 10$$

(3)
$$T_{amb}$$
 = 150 °C

Fig. 14. BC817-40QCH-Q: Base-emitter saturation voltage as a function of collector current; typical values



(3)
$$T_{amb} = -55$$
 °C

Fig. 15. BC817-40QCH-Q: Collector-emitter saturation voltage as a function of collector current; typical values

Product data sheet

11. Test information

11.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

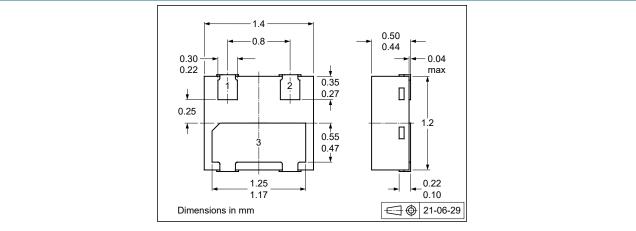
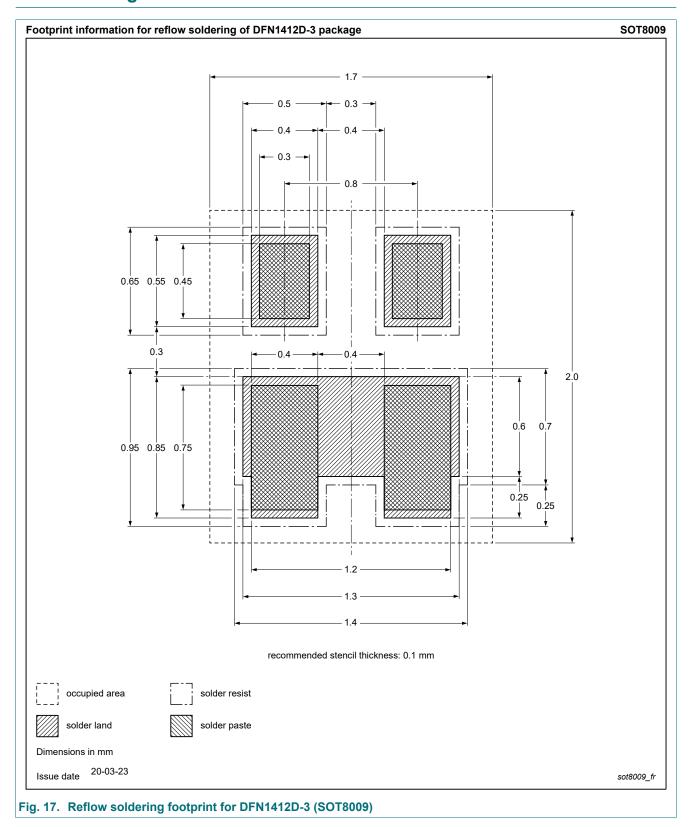


Fig. 16. Package outline DFN1412D-3 (SOT8009)

13. Soldering



14. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BC817QCH-Q_SER v.1	20220125	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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45 V, 500 mA NPN general-purpose transistors

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BC817QCH-Q_SER

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